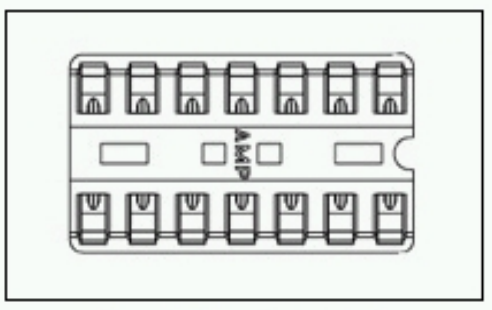
2-641261-1 Product Details

Live Product Chat



2-641261-1

TE Part Number: 2-641261-1

Active

Add to Part List

DIP Sockets

Always EU RoHS/ELV Compliant (Statement of Compliance)

Product Highlights:

- DIP Socket
- Number of Positions = 14
- Row-to-Row Spacing = 7.87 mm
- Thru Hole
- Mount Style = Vertical

View all Features | Find Similar Products

Quick Links

- Check Pricing & Availability
- Search for Tooling
- Product Feature Selector
- Contact Us About This Product
- Request Samples NEW!

Documentation & Additional Information

Product Drawings:

- SOCKET ASSY, DIP, RET LEG, 14 POS, DIPLOMATE DL - (PDF, English)

Catalog Pages/Data Sheets:

- None Available

Product Specifications:

- None Available

Application Specifications:

- DIPLOMATE DL (Dual Leaf) DIP Sockets (PDF, English)

Instruction Sheets:

- None Available

CAD Files:

- None Available

List all Documents

Additional Information:

- Product Line Information

Related Products:

- Tooling

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:

- Product Type = DIP Socket
- Number of Positions = 14
- Profile = Standard
- Frame Style = Closed
- Leg Style = Retention
- Proprietary Name = DIPLOMATE DL
- Color = Black
- Qty./Tube = 30
- Qty. Tubes/Box = 100
- Product Series = Standard
- Comment = ONLY sockets with straight solder tails are recommended for automatic insertion.

Electrical Characteristics:

- Insulation Resistance (MΩ) = 10,000
- Contact Resistance (mΩ) = 30

Termination Related Features:

- Termination (Solder) Post Length (mm [in]) = 3.05 [0.120]

Body Related Features:

- Row-to-Row Spacing (mm [in]) = 7.87 [0.310]
- Mount Style = Vertical
- Centerline (mm [in]) = 2.54 [0.100]

Contact Related Features:

- Contact Mount = Thru Hole
- Contact Material = Beryllium Copper
- Contact Mating Area Plating Material = Tin
- Contact Style = Stamped + Formed
- Mating Contact Type = Dual Leaf

Housing Related Features:

- Housing Material = Thermoplastic Glass Reinforced
- Housing Flammability Rating = UL 94V-0

Configuration Related Features:

- Height Above PC Board (mm [in]) = 5.33 [0.210]

Industry Standards:

- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- Lead Free Solder Processes = Wave solder capable to 240°C
- RoHS/ELV Compliance History = Always was RoHS compliant

Conditions for Usage:

- Temperature Range (°C) = 105

Operation/Application:

- Application = Production

Packaging Related Features:

- Packaging Method = Tube

Other:

- Brand = AMP

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